
PIR Motion Sensors

ISL28194 and ISL28915 in Low-Power,
PIR Motion Sensors Prolong Battery Life

TB512
Rev.0.00
Mar 16, 2018

Abstract

Sensor circuits in gas, fire, and burglar alarm systems normally draw their power from the electrical installation of the mains supplies. During power outages however, a sensor circuit's supply switches to battery power to ensure continued system operation until the mains supply is restored. Often this can take days and even weeks. To preserve battery life over this time span, the use of low-power sensors and ultra-low power op-amps and comparators, such as ISL28194 and ISL28915, with nano-amp quiescent currents are required.

This tech brief provides a design example of a signal conditioning stage for a motion detector using a Passive Infrared (PIR) sensor in combination with ultra-low power operational amplifiers and comparators.

Contents

1. Functional Principle and Construction of PIR Sensors	2
2. Sensor Signal Conditioning	3
2.1 Bandpass Filters	3
2.2 Window Comparator	5
2.3 Current Consumption	5
3. Conclusion	5
4. References	5
5. Revision History	6

List of Figures

Figure 1. PIR Motion Sensing Principle	2
Figure 2. The Signal Conditioning Circuit Comprises a 2nd Order Bandpass and a Window Comparator. 3	
Figure 3. Frequency Responses of AOL, $1/\beta$, $1-1/\beta$	4
Figure 4. Frequency Responses of G1, G2, and GT.	4

1. Functional Principle and Construction of PIR Sensors

PIR sensors are used for motion detection in security systems, automatic doors, and automatic light control to detect movements. For example, if a moving person or animal is detected in a specified area, an alarm may be triggered or a specific room may be lit. The Infrared (IR) energy, or heat of a moving object, depends on its temperature, color, and texture. This energy is not visible to the human eye, but PIR sensors can detect it.

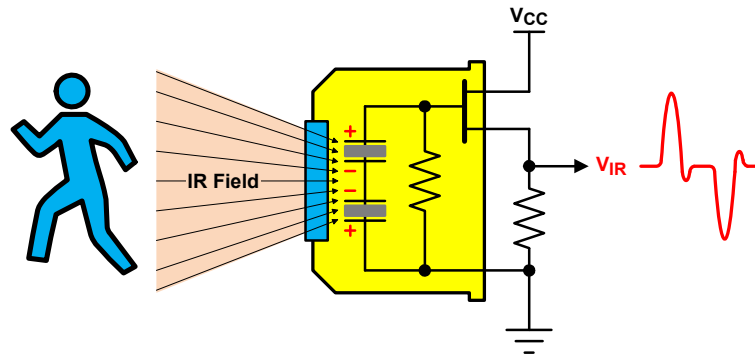


Figure 1. PIR Motion Sensing Principle

A PIR sensor consists of two or more pyroelectric elements that output a voltage proportional to the amount of incident infrared radiation. These elements are arranged in pairs and connected in series so that if each element detects the same amount of IR energy, as in the case of ambient room temperature or no motion, the resulting output is 0V. [Figure 1](#) shows the structure of a PIR motion sensor and its output signal during movement detection.

The output voltage signal results from a moving object having a different temperature than its environment. The movement parallel to the sensor surface and through the field of view of both pyroelectric elements creates a signal amplitude that is proportional to the speed and distance of the object relative to the sensor.

Due to the small physical size of the sensor elements (approximately 2mm² per element), a Fresnel lens is commonly placed in front of the PIR sensor to increase the distance and the field of view (angle) by focusing the IR energy onto the small sensor elements.

An important aspect of the PIR sensor is that upon its initial power up, it can take up to more than 30 seconds for the sensor output to stabilize. During this time, the sensor elements adjust themselves to the ambient background conditions. This long set-up time prohibits the application of power-cycling techniques, otherwise used to minimize battery drainage, and requires the sensor circuitry to be powered continuously.

2. Sensor Signal Conditioning

The sensor output during movement detection is a small AC signal component of typical $3\text{mV}_{\text{P-P}}$ to $4\text{mV}_{\text{P-P}}$ superimposed onto a high DC offset of 1V to 2V. To eliminate the DC offset and only amplify the AC component of the signal, two identical first order bandpass filters are connected in series (Figure 2). The filter output of the last stage is then fed into a window comparator. Its upper and lower reference voltage levels form switching thresholds, causing the comparator outputs to switch between VCC and GND, whenever the input signal exceeds either one of the thresholds. This switching action converts the analog input into digital output signals, thus representing a 1-bit analog-to-digital converter. The comparator outputs are connected to the I/O ports of a low-power microcontroller to indicate when motion has been detected.

2.1 Bandpass Filters

Each filter stage has a passband gain of 170V/V for an overall signal gain of 89dB. This gain is chosen to maximize the motion sensitivity range for the sensor bias point being used.

To limit the overall impact of $1/f$ noise of the analog front end while allowing for a minimum speed of motion that the sensor can detect, the cutoff or -3dB frequency of the high-pass section is set to 0.8Hz. To limit broadband noise, the amplifier's low Gain Bandwidth Product (GBW) of 3.5kHz is used to set the cutoff frequency of the low-pass section to 20Hz.

The first bandpass filter is a non-inverting gain stage that provides a high impedance input to the sensor, which ensures the sensor's bias point remains fixed. At the same time the sensor output bias voltage provides the DC bias for the first filter stage. Because of C_G this stage has unity gain at DC, preventing the amplification of input offset errors.

The second bandpass filter is an inverting gain stage that is AC-coupled to the first stage. This requires the DC bias to be taken from the center ($V_{\text{CC}}/2$) of the bias resistor string, R_{B1} to R_{B4} .

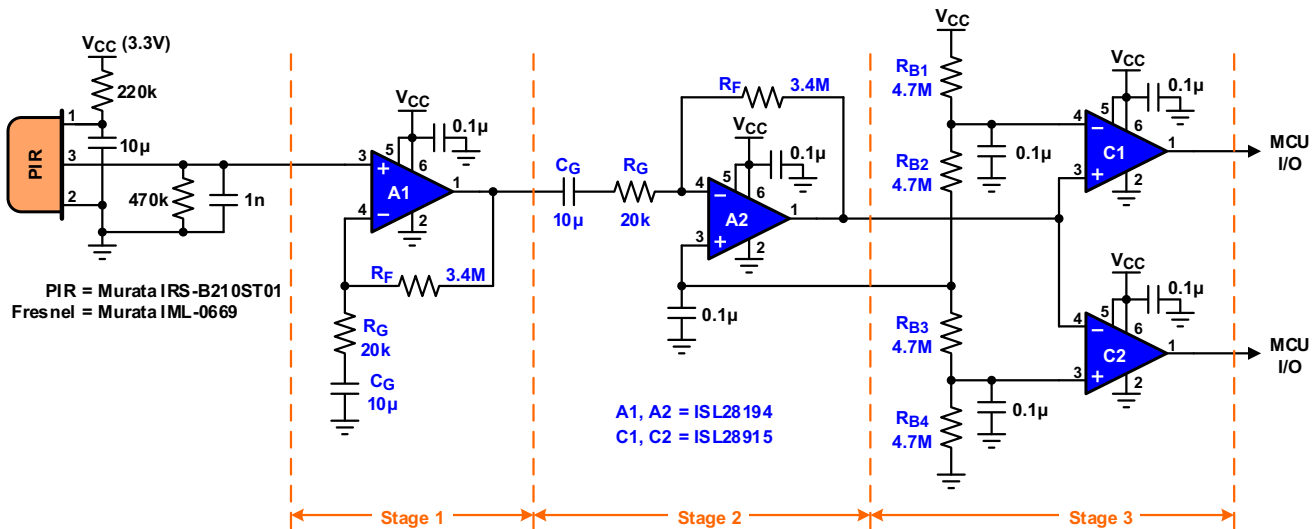


Figure 2. The Signal Conditioning Circuit Comprises a Second Order Bandpass and a Window Comparator

Equations 1 through 5 show the calculations of the gain factors and the cutoff frequencies for the individual filter stages.

$$(EQ. 1) \quad |G_1| = 1 + \frac{R_F}{R_G} = 1 + \frac{3.4M\Omega}{20k\Omega} = 171V/V = 44.7dB$$

$$(EQ. 2) \quad |G_2| = \frac{R_F}{R_G} = \frac{3.4M\Omega}{20k\Omega} = 170V/V = 44.6dB$$

$$(EQ. 3) \quad f_{Low-1,2} = \frac{1}{2\pi \cdot R_G \cdot C_G} = \frac{1}{2\pi \cdot 20k\Omega \cdot 10\mu F} = 0.8Hz$$

$$(EQ. 4) \quad f_{High-1} = \frac{GBW}{|G_1|} = \frac{3.5kHz}{171} = 20.5Hz$$

$$(EQ. 5) \quad f_{High-2} = \frac{GBW}{|G_2|} = \frac{3.5kHz}{170} = 20.6Hz$$

Therefore, total passband gain, G_T , is $G_1 \cdot G_2 = 29070V/V$ or 89.3dB.

Figure 3 depicts the ideal frequency responses of the noninverting gain stage ($1/\beta$) and the inverting gain stage ($1-1/\beta$). Their 20dB/decade rate-of-closure with the open-loop gain (A_{OL}) of the ISL28194 indicate about 90° of phase margin and sound stability. Figure 4 shows the real gain responses of the gain stages, G_1 and G_2 , and the total gain, G_T .

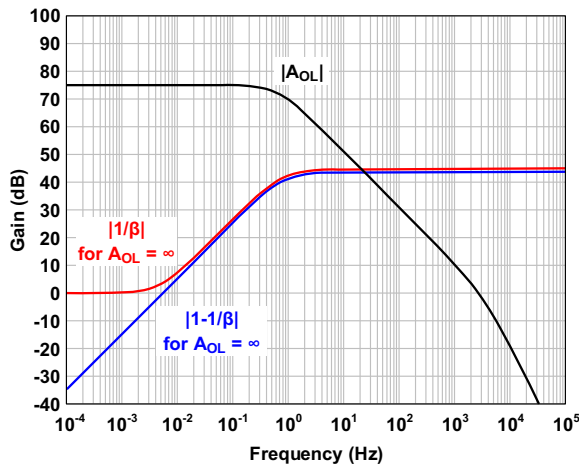


Figure 3. Frequency Responses of A_{OL} , $1/\beta$, $1-1/\beta$

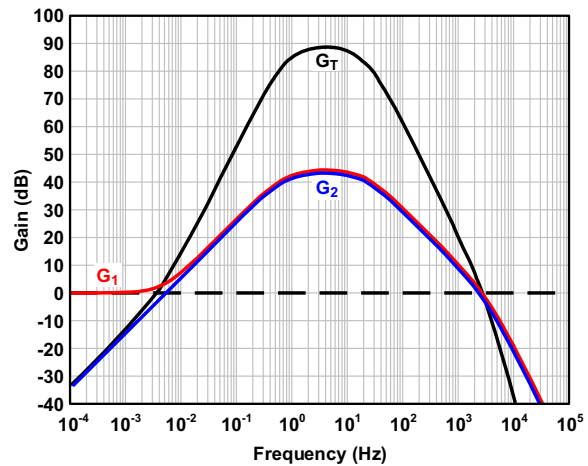


Figure 4. Frequency Responses of G_1 , G_2 , and G_T

2.2 Window Comparator

The third stage is a window comparator whose outputs signal to a microcontroller when movement is detected by turning the comparator outputs high. Voltage divider action of the bias resistor string, R_{B1} to R_{B4} sets the upper and lower switching thresholds of the comparators V_{TH-H} and V_{TH-L} , and the bias point for the second gain stage.

In the absence of movement, the second filter outputs a voltage between V_{TH-H} and V_{TH-L} , turning both push-pull comparator outputs low. When a heat source approaches, depending on the direction of movement, one of the comparator outputs will turn high first.

The switching thresholds for this sensor are set to $V_{TH-H} = 0.75 V_{CC}$ and $V_{TH-L} = 0.25 V_{CC}$. Making R_{B1} through $R_{B4} = R_B$, simplifies the equations for their calculations.

$$(EQ. 6) \quad V_{TH-H} = V_{CC} \cdot \frac{3R_B}{4R_B} = 0.75V_{CC}$$

$$(EQ. 7) \quad V_{TH-L} = V_{CC} \cdot \frac{R_B}{4R_B} = 0.25V_{CC}$$

2.3 Current Consumption

As power consumption is a key feature for battery powered applications, this three-stage architecture for motion detection has been designed for minimum current consumption at 3.3V to be compatible with Renesas low-power microcontrollers. Itemizing the current consumption by components ([Table 1](#)), reveals that the sensor current amounts to more than 50% of the total supply current.

Table 1. Supply Currents for $V_{CC} = 3.3V$

Circuit Path	Supply Current (Idle)
PIR Sensor	1.67 μ A
2 x ISL28194 Amplifiers	0.43 μ A
2 x ISL28915 Comparators	0.87 μ A
Resistor Bias String	0.18 μ A
Total Circuit	3.15μA

3. Conclusion

Battery backed-up motion sensors require ultra-low power amplifiers and comparators to preserve battery life during power outages. The Renesas nano-power amplifier, ISL28194, and nano-power comparator, ISL28915, represent one of industry's lowest-power signal conditioning components.

4. References

For more information on analog signal conditioning for Renesas microcontrollers visit our website.

- [ISL28194](#) datasheet, “Ultra-Small, Nano Power, Rail-to-Rail Input/Output Op Amp”
- [ISL28915](#) datasheet, “Nano Power, Push/Pull Output Comparator”
- IRS-B210ST0 datasheet, “Murata PIR Sensor”

5. Revision History

Rev.	Date	Description
0.00	Mar 16, 2018	Initial release

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.
Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
6. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
11. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
(Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.
(Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.4.0-1 November 2017)



SALES OFFICES

Renesas Electronics Corporation

<http://www.renesas.com>

Refer to "<http://www.renesas.com/>" for the latest and detailed information.

Renesas Electronics America Inc.

1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.
Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics Canada Limited

9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3
Tel: +1-905-237-2004

Renesas Electronics Europe Limited

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-651-700, Fax: +44-1628-651-804

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.

Room 1709 Quantum Plaza, No.27 ZhichunLu, Haidian District, Beijing, 100191 P. R. China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.

Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, 200333 P. R. China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited

Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2265-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd.

13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.

80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.

Unit 1207, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +60-3-7955-9390, Fax: +60-3-7955-9510

Renesas Electronics India Pvt. Ltd.

No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India
Tel: +91-80-67208700, Fax: +91-80-67208777

Renesas Electronics Korea Co., Ltd.

17F, KAMCO Yangjae Tower, 262, Gangnam-daero, Gangnam-gu, Seoul, 06265 Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5338